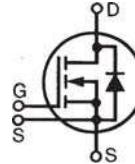


**HiPerFET™ Power  
MOSFETs Single Die  
MOSFET**

**IXFN280N085**

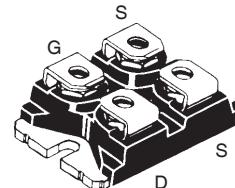
N-Channel Enhancement Mode  
Avalanche Rated, High dv/dt, Low  $t_{rr}$



**$V_{DSS} = 85V$**   
 **$I_{D25} = 280A$**   
 **$R_{DS(on)} \leq 4.4m\Omega$**

miniBLOC, SOT-227 B

E153432



G = Gate                      D = Drain  
S = Source

Either Source terminal at miniBLOC can be used as Main or Kelvin Source

Symbol	Test Conditions	Maximum Ratings		
$V_{DSS}$	$T_J = 25^\circ C$ to $150^\circ C$	85		V
$V_{DGR}$	$T_J = 25^\circ C$ to $150^\circ C$ , $R_{GS} = 1M\Omega$	85		V
$V_{GSS}$	Continuous	$\pm 20$		V
$V_{GSM}$	Transient	$\pm 30$		V
$I_{D25}$	$T_C = 25^\circ C$ , Chip capability	280	A	
$I_{L(RMS)}$	External Lead Current Limit	200	A	
$I_{DM}$	$T_C = 25^\circ C$ , pulse width limited by $T_{JM}$	1120	A	
$I_A$	$T_C = 25^\circ C$	200	A	
$E_{AS}$	$T_C = 25^\circ C$	4	J	
$dV/dt$	$I_S \leq I_{DM}$ , $V_{DD} \leq V_{DSS}$ , $T_J \leq 150^\circ C$	5		V/ns
$P_d$	$T_C = 25^\circ C$	700		W
$T_J$		-55 ... +150		°C
$T_{JM}$		150		°C
$T_{stg}$		-55 ... +150		°C
$V_{ISOL}$	50/60 Hz, RMS $t = 1\text{ min}$ $I_{ISOL} \leq 1\text{ mA}$ $t = 1\text{ s}$	2500 3000	V~ V~	
$M_d$	Mounting torque Terminal connection torque	1.5/13 1.3/11.5	Nm/lb.in. Nm/lb.in.	
Weight		30		g

Symbol	Test Conditions	Characteristic Values		
		( $T_J = 25^\circ C$ , unless otherwise specified)	Min.	Typ.
$BV_{DSS}$	$V_{GS} = 0V$ , $I_D = 3\text{ mA}$	85		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 8\text{ mA}$	2.0		V
$I_{GSS}$	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$		$\pm 200$	nA
$I_{DSS}$	$V_{DS} = V_{DSS}$ $V_{GS} = 0V$		100 2	$\mu A$ mA
$R_{DS(on)}$	$V_{GS} = 10V$ , $I_D = 100A$ , Note 1		4.4	$m\Omega$

### Features

- International standard package
- miniBLOC, with Aluminium nitride isolation
- Low  $R_{DS(on)}$  HDMOS™ process
- Rugged polysilicon gate cell structure
- Avalanche rated
- Guaranteed FBSOA
- Low package inductance
- Fast intrinsic Rectifier

### Advantages

- Easy to mount
- Space savings
- High power density

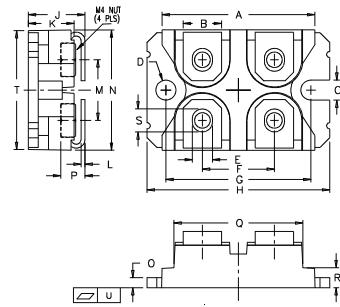
### Applications

- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- Temperature and lighting controls

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 10\text{V}$ , $I_D = 60\text{A}$ , Note 1	60	100	S
$C_{iss}$			19	nF
$C_{oss}$			6.4	nF
$C_{rss}$			3.2	nF
$t_{d(on)}$	<b>Resistive Switching Times</b> $V_{GS} = 10\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 60\text{A}$ $R_G = 1\Omega$ (External)		40	ns
$t_r$			150	ns
$t_{d(off)}$			112	ns
$t_f$			60	ns
$Q_{g(on)}$		580		nC
$Q_{gs}$		77		nC
$Q_{gd}$		280		nC
$R_{thJC}$			0.18	°C/W
$R_{thCS}$		0.05		°C/W

**Source-Drain Diode**

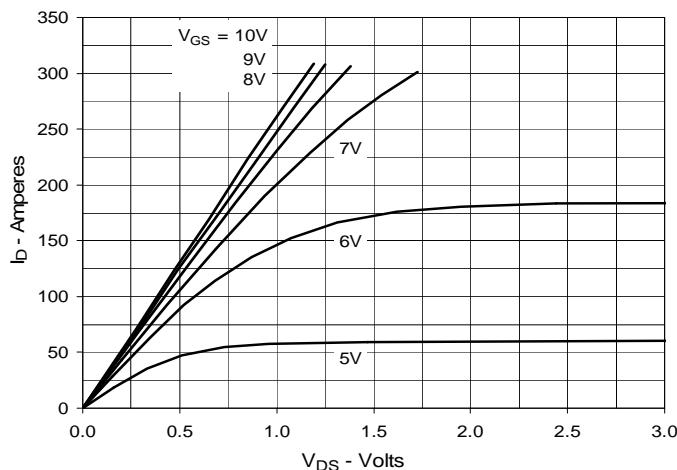
Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
$I_s$	$V_{GS} = 0\text{V}$		280	A
$I_{sm}$	Repetitive, pulse width limited by $T_{JM}$		1120	A
$V_{SD}$	$I_F = 100\text{A}$ , $V_{GS} = 0\text{V}$ , Note 1		1.2	V
$t_{rr}$	$I_F = 50\text{A}$ , $-di/dt = 100\text{A}/\mu\text{s}$ , $V_R = 50\text{V}$		200	ns
$Q_{RM}$		0.76		μC
$I_{RM}$		8.00		A

Note 1: Pulse test,  $t \leq 300\mu\text{s}$ ; duty cycle,  $d \leq 2\%$ .**miniBLOC, SOT-227 B**

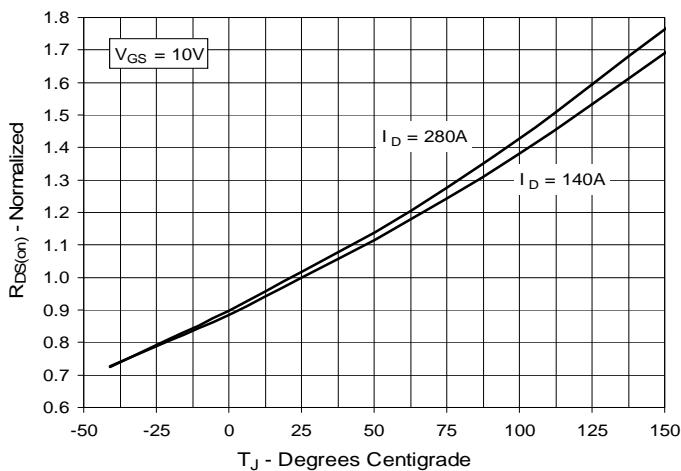
M4 screws (4x) supplied

Dim.	Millimeter Min.	Millimeter Max.	Inches Min.	Inches Max.
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	38.00	38.23	1.496	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.76	0.84	0.030	0.033
M	12.60	12.85	0.496	0.506
N	25.15	25.42	0.990	1.001
O	1.98	2.13	0.078	0.084
P	4.95	5.97	0.195	0.235
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.174
S	4.72	4.85	0.186	0.191
T	24.59	25.07	0.968	0.987
U	-0.05	0.1	-0.002	0.004

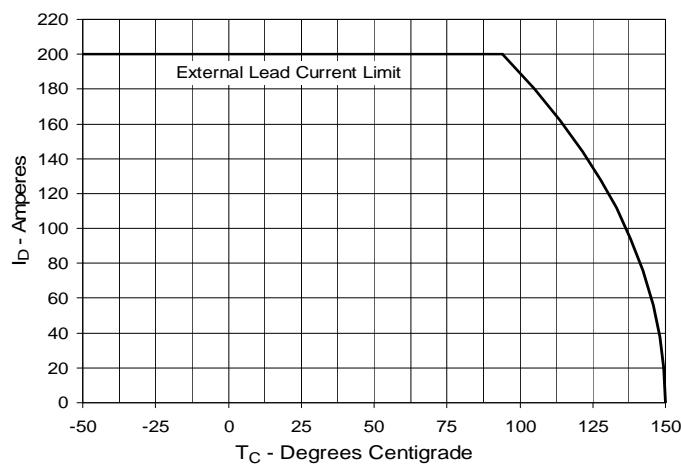
**Fig. 1. Extended Output Characteristics  
@ 25°C**



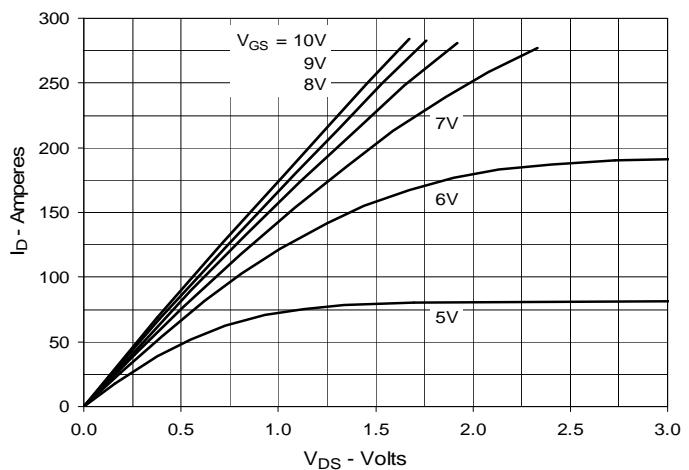
**Fig. 3.  $R_{DS(on)}$  Normalized to  $I_D = 140A$  Value  
vs. Junction Temperature**



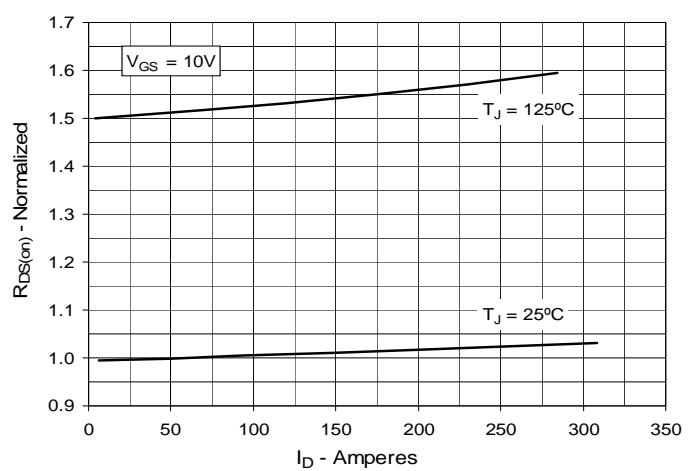
**Fig. 5. Maximum Drain Current vs.  
Case Temperature**



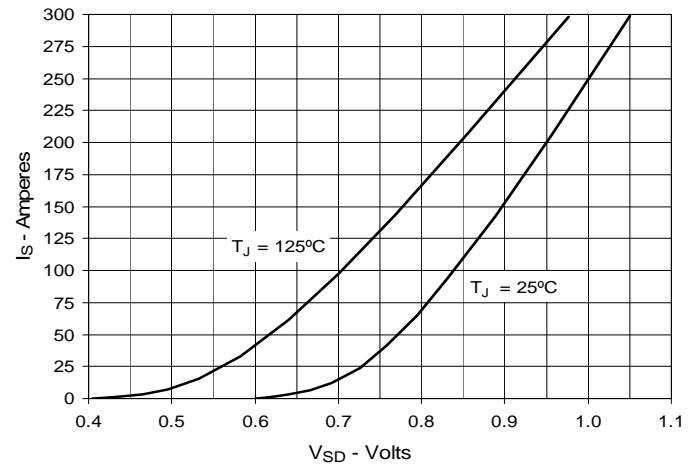
**Fig. 2. Output Characteristics  
@ 125°C**

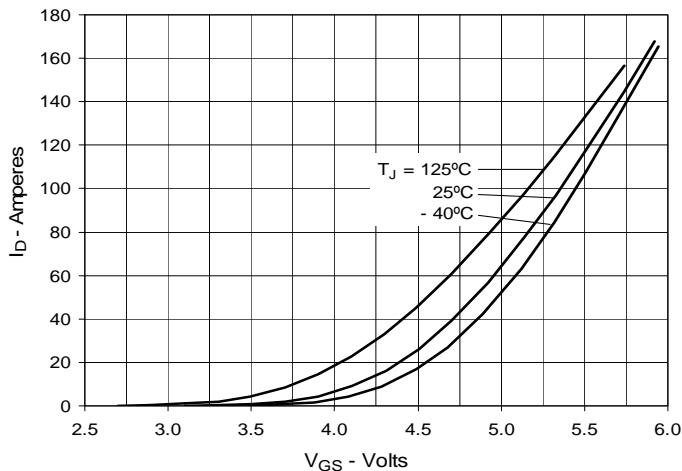
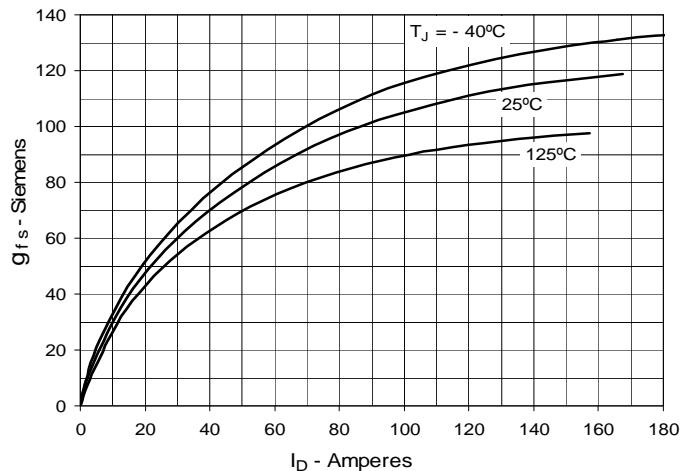
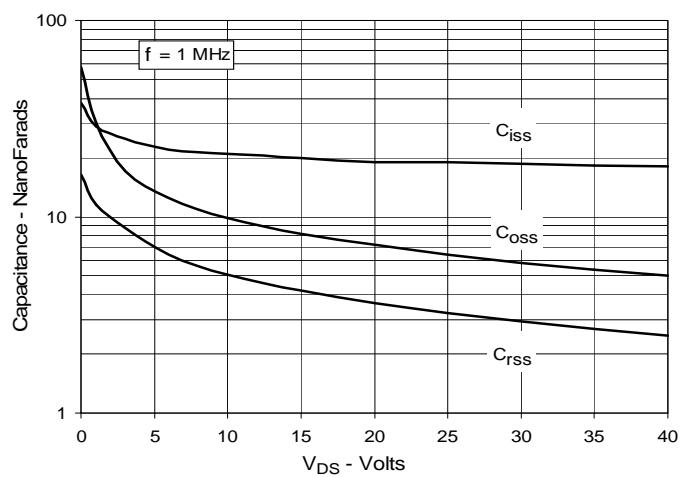
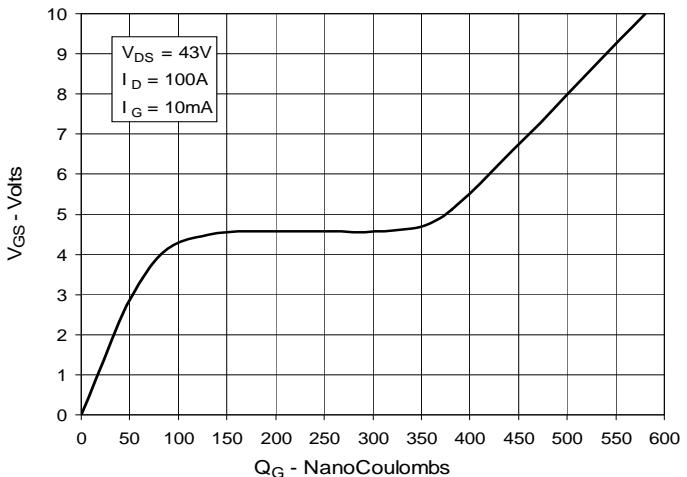
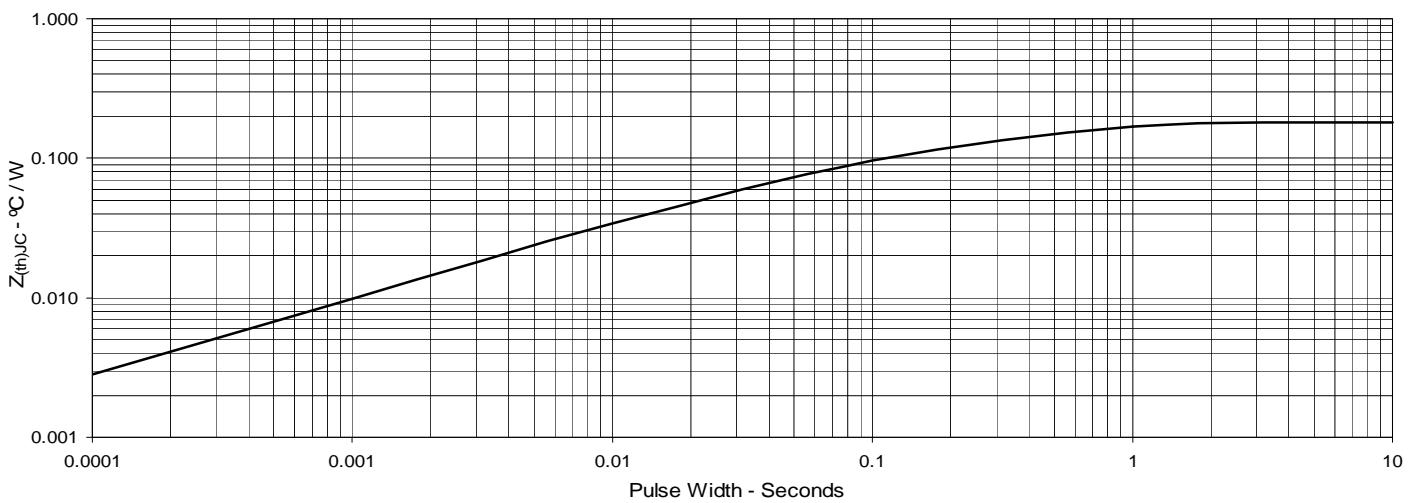


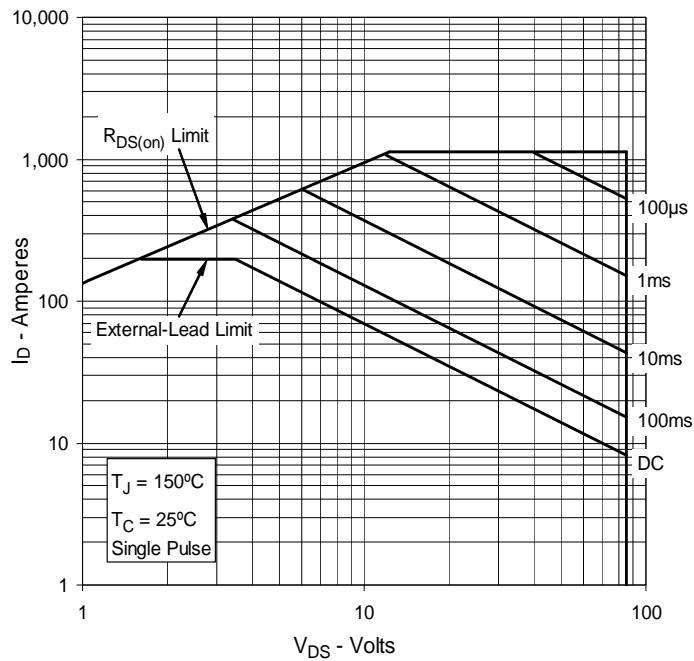
**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 140A$  Value  
vs. Drain Current**



**Fig. 6. Forward Voltage Drop of  
Intrinsic Diode**



**Fig. 7. Input Admittance****Fig. 8. Transconductance****Fig. 9. Capacitance****Fig. 10. Gate Charge****Fig. 11. Maximum Transient Thermal Impedance**

**Fig. 12. Forward-Bias Safe Operating Area**@  $T_C = 25^\circ\text{C}$ **Fig. 13. Forward-Bias Safe Operating Area**@  $T_C = 75^\circ\text{C}$ 